

Maximum Ratings (@ $T_A = +25$ °C, unless otherwise specified.)

Characteristic			Symbol	Value	Unit
Drain-Source Voltage			V _{DSS}	-30	V
Gate-Source Voltage			V _{GSS}	±25	V
Continuous Drain Current (Note 6) V _{GS} = -10V	Steady State	$T_A = +25^{\circ}C$ $T_A = +70^{\circ}C$	I _D	-12 -10	А
Continuous Drain Current (Note 7) V _{GS} = -10V	Steady State	$T_C = +25$ °C $T_C = +70$ °C	I _D	-35 -25	А
Maximum Continuous Body Diode Forward Current (Note 7)			I _S	-35	Α
Pulsed Drain Current (380µs Pulse, Duty Cycle = 1%)			I _{DM}	-80	Α
Pulsed Body Diode Forward Current (380µs Pulse, Duty Cycle = 1%)			I _{SM}	-80	Α
Avalanche Current (Note 8) L = 1mH			I _{AS}	-14	Α
Avalanche Energy (Note 8) L = 1mH			E _{AS}	100	mJ

Thermal Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic		Symbol	Value	Unit
Total Power Dissipation (Note 5)	T _A = +25°C	P _D	0.94	W
Thermal Resistance, Junction to Ambient (Note 5)	Steady State	R _{OJA}	134	°C/W
Total Power Dissipation (Note 6)	T _A = +25°C	P _D	1.94	W
Thermal Resistance, Junction to Ambient (Note 6)	Steady State	R _{OJA}	65	°C/W
Total Power Dissipation (Note 7)		P _D	31	W
Thermal Resistance, Junction to Case (Note 7)		R _{eJC}	4.0	°C/W
Operating and Storage Temperature Range		T _J , T _{STG}	-55 to +150	°C

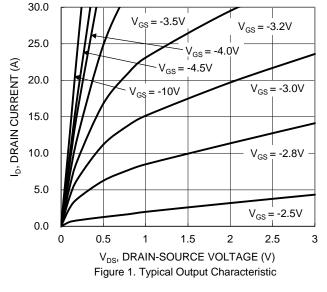
Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 9)							
Drain-Source Breakdown Voltage	BV _{DSS}	-30	_	_	V	$V_{GS} = 0V, I_{D} = -250\mu A$	
Zero Gate Voltage Drain Current	I _{DSS}	_	_	-1	μΑ	$V_{DS} = -24V, V_{GS} = 0V$	
Gate-Source Leakage	I _{GSS}	_	_	±10	μΑ	$V_{GS} = \pm 20V, V_{DS} = 0V$	
ON CHARACTERISTICS (Note 9)							
Gate Threshold Voltage	V _{GS(TH)}	-1.0	_	-3.0	V	$V_{DS} = V_{GS}, I_{D} = -250 \mu A$	
Static Drain-Source On-Resistance		_	8	9.5	mΩ	$V_{GS} = -10V, I_D = -11.5A$	
Static Drain-Source On-Resistance	R _{DS(ON)}	_	11	17		$V_{GS} = -4.5V$, $I_{D} = -8.5A$	
Diode Forward Voltage	V _{SD}	_	-0.7	-1.2	V	$V_{GS} = 0V, I_{S} = -1A$	
DYNAMIC CHARACTERISTICS (Note 10)							
Input Capacitance	C _{iss}	_	1674	_	pF	45)/)/ 0)/	
Output Capacitance	Coss	_	302	_	pF	$V_{DS} = -15V, V_{GS} = 0V,$	
Reverse Transfer Capacitance	C _{rss}	_	230	_	pF	f = 1.0MHz	
Gate Resistance	Rg	_	15.2	_	Ω	$V_{DS} = 0V, V_{GS} = 0V, f = 1.0MHz$	
Total Gate Charge (V _{GS} = -5V)	Qg	_	16.2	_	nC		
Total Gate Charge (V _{GS} = -10V)	Qg	_	33.7	_	nC	V _{DS} = -15V, I _D = -11.5A	
Gate-Source Charge	Q _{qs}	_	3.5	_	nC		
Gate-Drain Charge	Q _{gd}	_	6.7	_	nC		
Turn-On Delay Time	t _{D(ON)}	_	4.0	_	ns		
Turn-On Rise Time	t _R	_	4.5	_	ns	$V_{DD} = -15V, V_{GS} = -10V,$ $R_G = 6\Omega, I_D = -11.5A$	
Turn-Off Delay Time	t _{D(OFF)}	_	96	_	ns		
Turn-Off Fall Time	t _F	_	106.5	_	ns		
Reverse Recovery Time	t _{RR}	_	46	_	ns	I _S = -11.5A, dl/dt = 100A/μs	
Reverse Recovery Charge	Q_{RR}	_	25.5	_	nC		

Notes: 5. De

- 5. Device mounted on FR-4 PC board, with minimum recommended pad layout, single sided.
- 6. Device mounted on FR-4 substrate PC board, 2oz copper, with thermal bias to bottom layer 1-inch square copper plate.
- 7. Thermal resistance from junction to soldering point (on the exposed drain pad).
- 8. I_{AS} and E_{AS} ratings are based on low frequency and duty cycles to keep $T_J = +25$ °C.
- 9. Short duration pulse test used to minimize self-heating effect.
- 10. Guaranteed by design. Not subject to product testing.





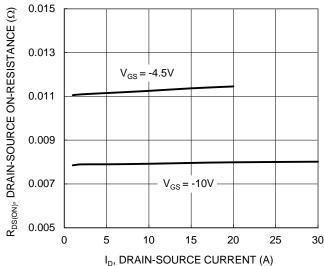


Figure 3. Typical On-Resistance vs. Drain Current and Gate Voltage

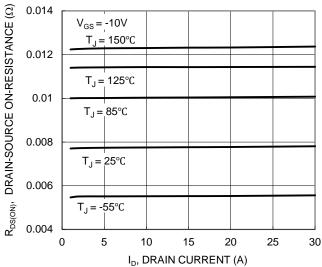
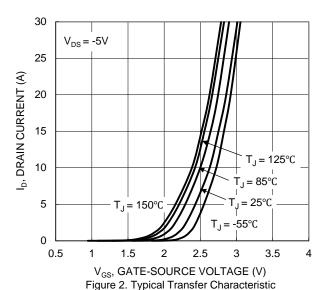


Figure 5. Typical On-Resistance vs. Drain Current and Junction Temperature



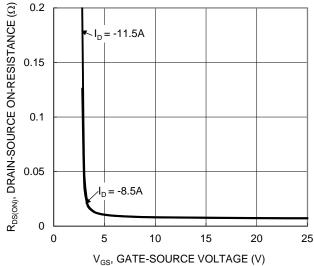
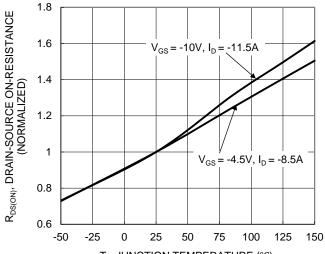


Figure 4. Typical Transfer Characteristic



T_J, JUNCTION TEMPERATURE (°C)
Figure 6. On-Resistance Variation with Junction
Temperature



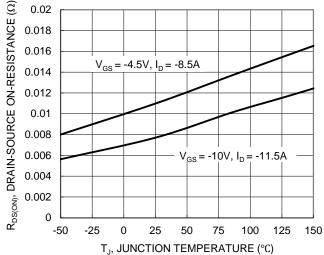
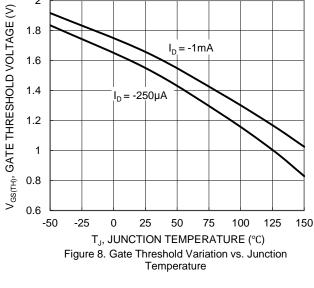
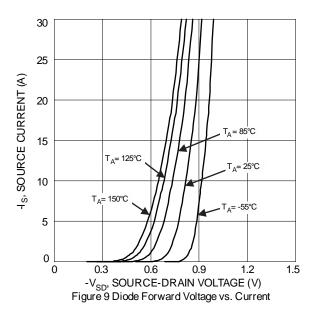
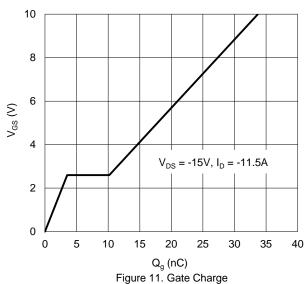


Figure 7. On-Resistance Variation with Junction Temperature



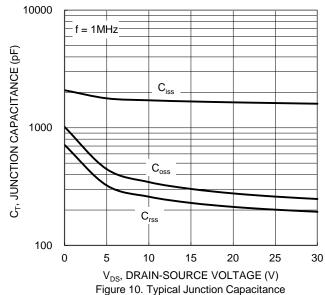
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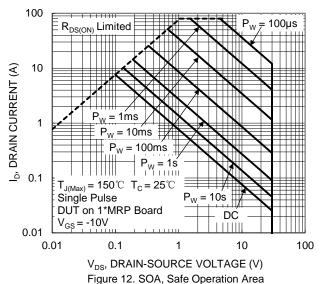




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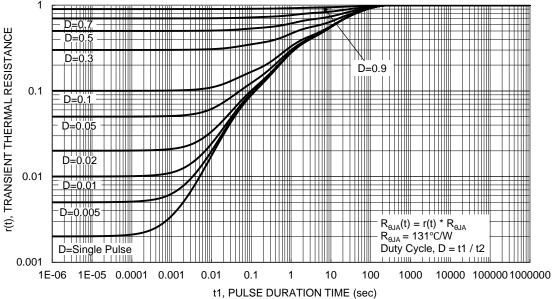


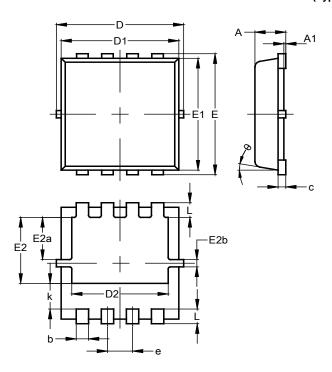
Figure 13. Transient Thermal Resistance



Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

PowerDI3333-8 (Type UX)

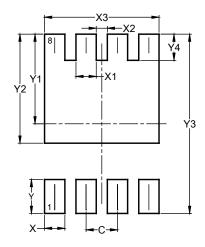


PowerDI3333-8						
(Type UX)						
Dim	Min	Max	Тур			
Α	0.75	0.85	0.80			
A1	0.00	0.05				
b	0.25	0.40	0.32			
С	0.10	0.25	0.15			
D	3.20	3.40	3.30			
D1	2.95	3.15	3.05			
D2	2.30	2.70	2.50			
Е	3.20	3.40	3.30			
E1	2.95	3.15	3.05			
E2	1.60	2.00	1.80			
E2a	0.95	1.35	1.15			
E2b	0.10	0.30	0.20			
е	0.65 BSC					
k	0.50	0.90	0.70			
L	0.30	0.50	0.40			
θ	0°	12°	10°			
All Dimensions in mm						

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

PowerDI3333-8 (Type UX)



Dimensions	Value (in mm)
С	0.650
X	0.420
X1	0.420
X2	0.230
Х3	2.370
Υ	0.700
Y1	1.850
Y2	2.250
Y3	3.700
Y4	0.540



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